SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- **Totally Lead-Free Finish & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP capable (Note 4)**

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). Solderable per MIL-STD-202, Method 208 e3
- Polarity: Cathode Band
- Weight: 0.004 grams (Approximate)

SOD323



Top View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
B0530WS-7-F	AEC-Q101	SOD323	3,000/Tape & Reel
B0530WS-13-F	AEC-Q101	SOD323	10,000/Tape & Reel
B0530WSQ-13-F	Automotive	SOD323	10,000/Tape & Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
5. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information

SOD323



SE = Product Type Marking Code

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Average Rectified Output Current (See Figure 1)	I_O	0.5	A
Peak Repetitive Forward Current tp = 8.3ms, Half Sine-Wave	I_{FRM}	3.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	2	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	235	mW
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	426	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-40 to +125	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	30	—	—	V	I_R = 500µA
Forward Voltage Drop	V_F	— —	— 0.40	0.36 0.45	V	I_F = 0.1A I_F = 0.5A
Leakage Current (Note 7)	I_R	— — —	— — —	80 100 500	µA	V_R = 15V V_R = 20V V_R = 30V
Total Capacitance	C_T	—	58	—	pF	f = 1MHz, V_R = 0V DC

Notes: 6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
7. Short duration pulse test used to minimize self-heating effect.

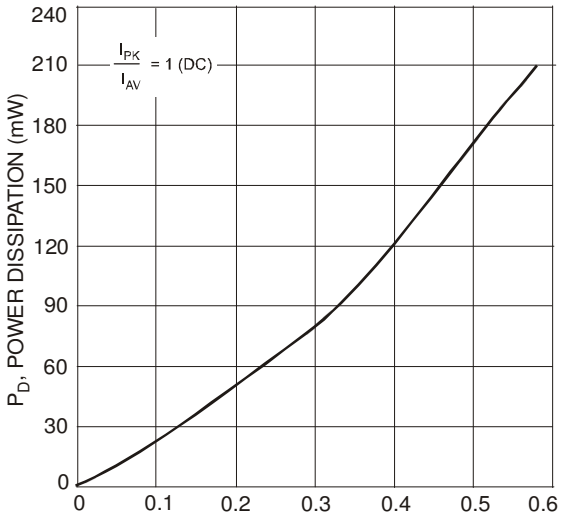

Fig. 1 Forward Power Dissipation

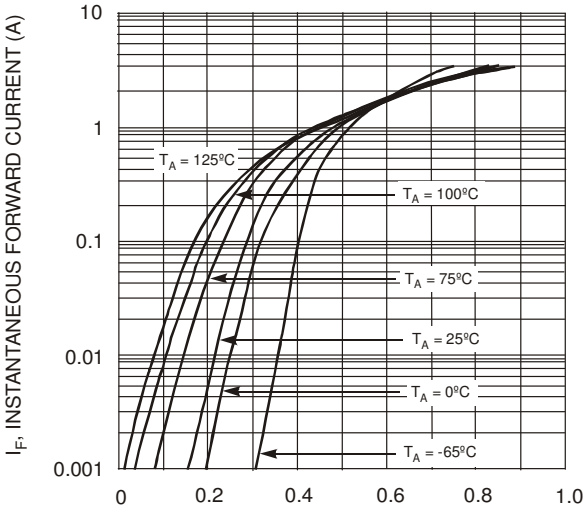

Fig. 2 Typical Forward Characteristics

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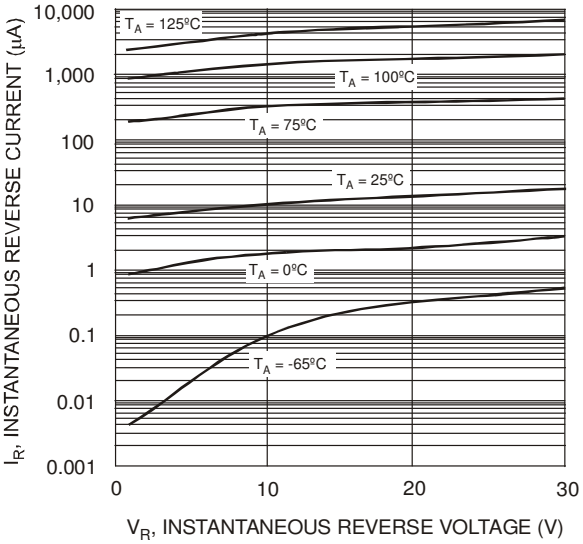

Fig. 3 Typical Reverse Characteristics

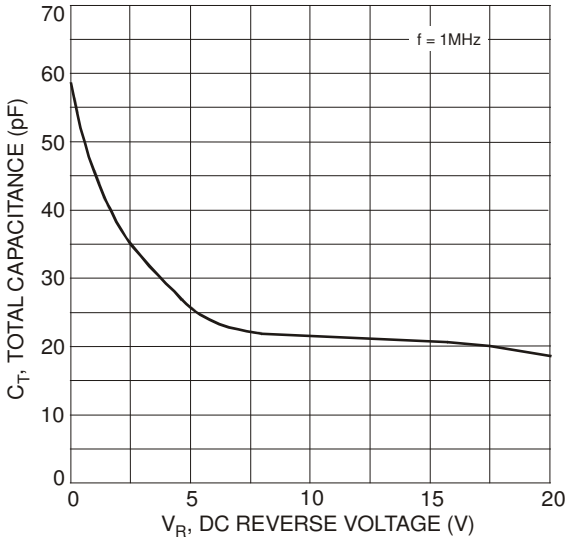

Fig. 4 Total Capacitance vs. Reverse Voltage

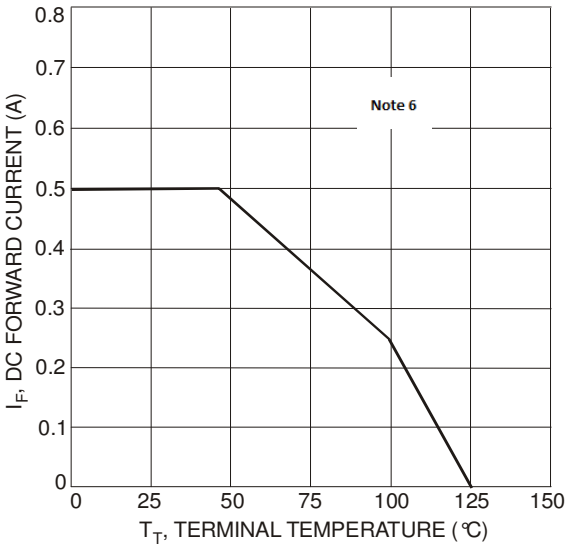

Fig. 5 Forward Current Derating Curve

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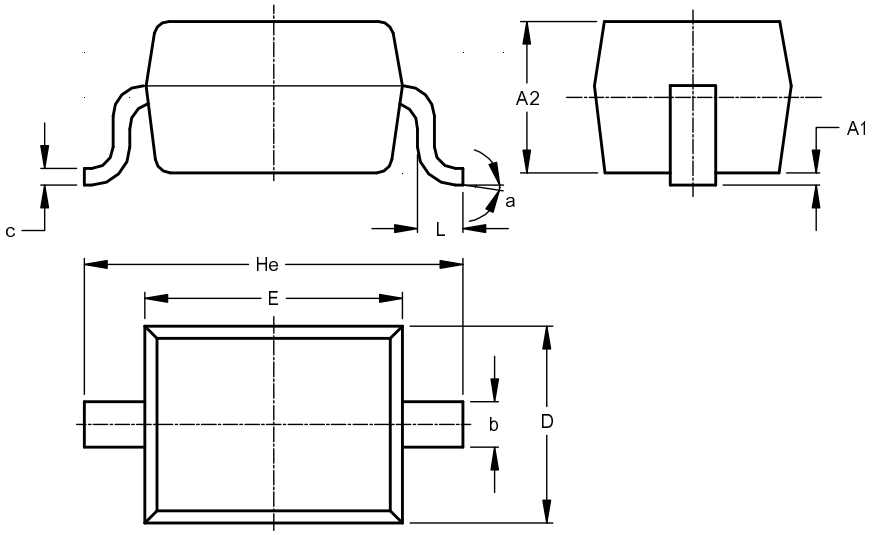
Package Outline Dimensions

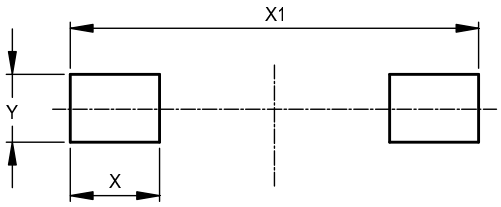
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD323			
Dim	**Min**	**Max**	**Typ**
A1	--	0.10	0.05
A2	1.00	1.10	1.05
b	0.25	0.35	0.30
c	0.10	0.15	0.11
D	1.20	1.40	1.30
E	1.60	1.80	1.70
He	2.30	2.70	2.50
L	0.20	0.40	0.30
a	8º		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X	0.590
X1	2.700
Y	0.450

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